Schottky Rectifier, 5.5 A

FEATURES

- Popular D-PAK outline
- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Compliant to RoHS Directive 2002/95/EC
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 $^\circ\text{C}$

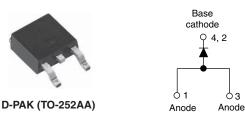
DESCRIPTION

The VS-50WQ04FNPbF surface mount Schottky rectifier has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS									
SYMBOL	CHARACTERISTICS	VALUES	UNITS						
I _{F(AV)}	Rectangular waveform	5.5	A						
V _{RRM}		40	V						
I _{FSM}	t _p = 5 μs sine	340	A						
V _F	5 Apk, T _J = 125 °C	0.44	V						
TJ	Range	- 40 to 150	°C						

VOLTAGE RATINGS									
PARAMETER	SYMBOL	VS-50WQ04FNPbF UNITS							
Maximum DC reverse voltage	V _R	40	V						
Maximum working peak reverse voltage	V _{RWM}	40	V						

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONE	VALUES	UNITS				
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at $T_C = 135$ °C,	5.5					
Maximum peak one cycle non-repetitive surge current		5 µs sine or 3 µs rect. pulse	s sine or 3 µs rect. pulse Following any rated load condition and with rated		А			
See fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	V _{RRM} applied	90				
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 \text{ °C}, I_{AS} = 1.5 \text{ A}, L = 8 \text{ mH}$		9	mJ			
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _B typical		1.2	А			



PRODUCT SUMMARY							
Package	D-PAK (TO-252AA)						
I _{F(AV)}	5.5 A						
V _R	40 V						
V_F at I_F	See Electrical table						
I _{RM}	40 mA at 125 °C						
T _J max.	150 °C						
Diode variation	Single die						
E _{AS}	9 mJ						



VS-50WQ04FNPbF

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ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST COND	VALUES	UNITS			
		5 A	T.I = 25 °C	0.51	V		
Maximum forward voltage drop	V (1)	10 A	1j=25 C	0.63			
See fig. 1	V _{FM} ⁽¹⁾	5 A	T 105 %C	0.44			
		10 A	T _J = 125 °C	0.59			
Maximum reverse leakage current	I _{RM} ⁽¹⁾	T _J = 25 °C	$V_{\rm B}$ = Rated $V_{\rm B}$	3	mA		
See fig. 2	IRM (''	T _J = 125 °C	$v_{\rm R} = haleu v_{\rm R}$	40			
Thereshold voltage	V _{F(TO)}	T _J =T _J maximum		0.27	V		
Forward slope resistance	r _t			26.77	mΩ		
Typical junction capacitance	CT	$V_R = 5 V_{DC}$ (test signal range 1	405	pF			
Typical series inductance	L _S	Measured lead to lead 5 mm f	5.0	nH			

Note

⁽¹⁾ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	T _J ⁽¹⁾ , T _{Stg}		- 40 to 150	°C				
Maximum thermal resistance, junction to case	R _{thJC}	DC operation See fig. 4	3.0	°C/W				
Approvimate weight			0.3	g				
Approximate weight			0.01	oz.				
Marking device		Case style D-PAK (similar to TO-252AA)	50WQ0	04FN				

Note

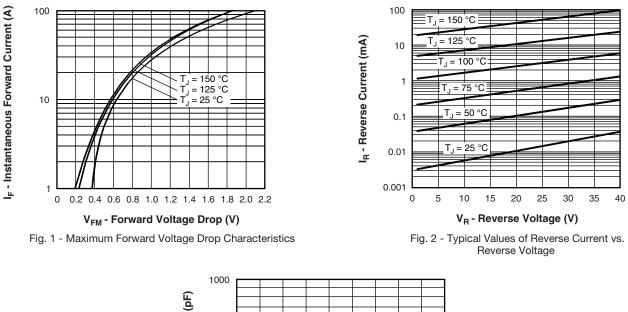
(1) $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$ thermal runaway condition for a diode on its own heatsink



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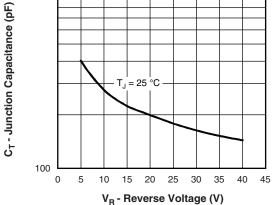


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

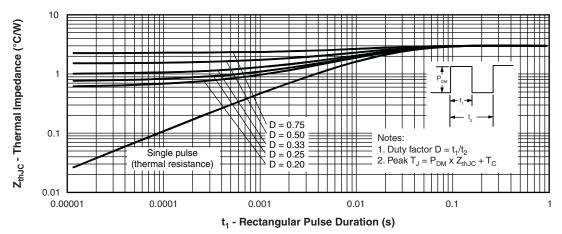


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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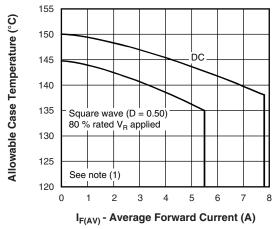
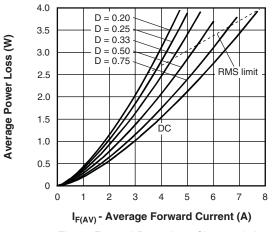
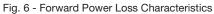


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current





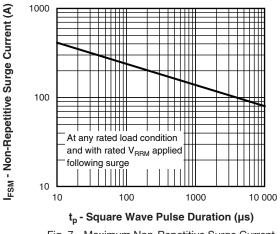


Fig. 7 - Maximum Non-Repetitive Surge Current

Note

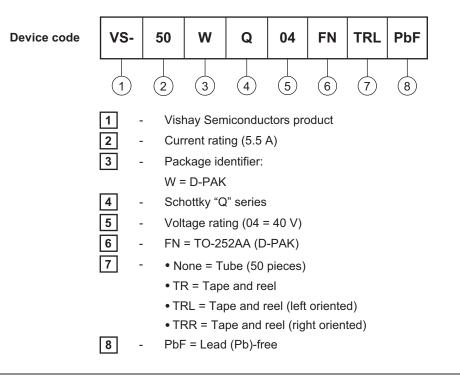
- ⁽¹⁾ Formula used: $T_C = T_J (Pd + Pd_{REV}) \times R_{thJC}$;
- $\begin{array}{l} \mathsf{Pd} = \mathsf{Forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \ x \ \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see fig. 6}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{Inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \ x \ \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{80} \ \% \ \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$



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ORDERING INFORMATION TABLE



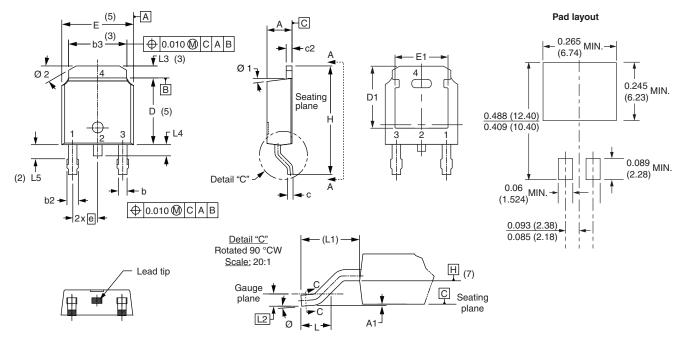
LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95016						
Part marking information	www.vishay.com/doc?95059						
Packaging information	www.vishay.com/doc?95033						





D-PAK (TO-252AA)

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	INCHES		NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
А	2.18	2.39	0.086	0.094			е	2.29	BSC	0.090	BSC	
A1	-	0.13	-	0.005			Н	9.40	10.41	0.370	0.410	
b	0.64	0.89	0.025	0.035			L	1.40	1.78	0.055	0.070	
b2	0.76	1.14	0.030	0.045			L1	2.74	BSC	0.108	REF.	
b3	4.95	5.46	0.195	0.215	3		L2	0.51	BSC	0.020	BSC	
С	0.46	0.61	0.018	0.024			L3	0.89	1.27	0.035	0.050	3
c2	0.46	0.89	0.018	0.035			L4	-	1.02	-	0.040	
D	5.97	6.22	0.235	0.245	5		L5	1.14	1.52	0.045	0.060	2
D1	5.21	-	0.205	-	3		Ø	0°	10°	0°	10°	
E	6.35	6.73	0.250	0.265	5		Ø1	0°	15°	0°	15°	
E1	4.32	-	0.170	-	3		Ø2	25°	35°	25°	35°	

Notes

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994

(2) Lead dimension uncontrolled in L5

⁽³⁾ Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad

(4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip

(5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁶⁾ Dimension b1 and c1 applied to base metal only

⁽⁷⁾ Datum A and B to be determined at datum plane H

⁽⁸⁾ Outline conforms to JEDEC outline TO-252AA

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